

**IN THE CLAIMS:**

Please note that all claims currently pending and under consideration in the referenced application are shown below, in clean form, for clarity.

Please amend the claims as follows:

1. (Previously Amended) A memory module, comprising:  
a substrate;  
at least two sites on said substrate, each of said at least two sites having mounted thereon a memory chip with substantially the same memory capacity, said memory chips providing a memory capacity for said memory module; and  
at least one other site on said substrate for mounting at least one additional memory chip thereon, said at least one additional memory chip having a functional memory less than said memory capacity of said memory module.
2. (Previously Amended) A memory module, comprising:  
a substrate;  
at least two sites on said substrate, each of said at least two sites having mounted thereon a memory chip with substantially the same memory capacity, said memory chips providing a memory capacity for said memory module; and  
at least one other site on said substrate configured to accept either of at least two other memory chips of different sizes.
3. (Three Times Amended) A memory module, comprising:  
a substrate having a plurality of memory chips mounted thereon; and  
a programmable device adapted to reroute input and output paths to and from said plurality of memory chips to bypass nonfunctional memory in at least one of said plurality of memory chips, extending to one or more additional locations on said substrate and configured to incorporate functional memory of one or more additional chips disposed at said one or more additional locations and selected in relation to an amount of detected nonfunctional

memory of said plurality of memory chips on said substrate into said rerouted input and output paths.

4. (Previously Amended) The memory module of claim 3, further comprising at least one additional memory chip mounted on at least one of said additional locations, operably coupled to said programmable device and providing functional memory in an amount equivalent to or greater than said nonfunctional memory.

5. (Previously Amended) The memory module of claim 4, wherein said at least one additional memory chip contains at least some nonfunctional memory.

6. (Three Times Amended) The memory module of claim 4, wherein said at least one additional memory chip comprises at least two memory chips having different memory capacity and being placed at different additional locations.

7. (Previously Twice Amended) The memory module of claim 3, wherein said programmable device comprises an EEPROM.

8. (Three Times Amended) A memory module comprising:  
a plurality of chips mounted to a substrate, said plurality of chips collectively exhibiting an amount of detected nonfunctional memory exceeding a memory capacity of any one chip of said plurality; and  
at least one additional memory chip mounted to said substrate providing an amount of functional memory selected in relation to and equal to or greater than said amount of detected nonfunctional memory.

9. The module of claim 8, wherein said at least one additional memory chip comprises at least two memory chips having different amounts of functional memory.

10. The memory module of claim 5, wherein said at least one additional memory chip contains an amount of functional memory substantially equal to an amount of nonfunctional memory in said at least one of said plurality of memory chips.

11. The memory module of claim 4, wherein said at least one additional memory chip contains an amount of functional memory substantially equal to an amount of nonfunctional memory in said at least one of said plurality of memory chips.

12. The memory module of claim 8, wherein said at least one additional memory chip provides an amount of functional memory substantially equal to said amount of nonfunctional memory collectively exhibited by said plurality of memory chips.

13. The memory module of claim 8, wherein said at least one additional memory chip contains at least some nonfunctional memory.

14. The memory module of claim 13, wherein said at least one additional memory chip provides an amount of functional memory substantially equal to said amount of nonfunctional memory collectively exhibited by said plurality of memory chips.